

General Description

Based on flyback topology, the AP3125A EV1 board is designed to serve as an example for cost-effective power solutions suitable for IoT applications. Rated at 25W power output, AP3125A EV1 board accepts universal AC voltage input while delivers 12V@2A and 5V@0.2A for IoT main functions as well as for IoT connectivity. The AP3125A EV1 meets DOE VI and CoC Tier 2 energy efficiency requirement with standby power lower than 0.2W.

Key Features

- 90 ~265V_{AC} input range
- Current mode control & 65KHz operation switching frequency
- Over 85% Efficiency
- Very low standby input power <0.2W
- Low start-up operating and quiescent currents
- Soft start during startup process.
- Working at CCM mode when AC input is lower and at DCM mode when AC input is higher
- Frequency fold back for high average efficiency
- Built-in Jittering Frequency
- Soft Switching for Reducing EMI
- Internal Auto Recovery OCP, OVP, OLP, OTP Power Protection, cycle by cycle current limit, also with DC polarity protection

Applications

- Switching AC-DC Adaptor & Charger
- Power home Appliances
- Set-top box power supply
- Open frame switching power supply
- Gaming system

AP3125A universal AC input EV1 Specifications (CV mode)

Parameter	Value
Input Voltage	90 to 265V _{AC}
Input standby power	0.2 W
Main output Vo / Io	12V - 2A
Second output Vos/los	5V - 0.2A
Efficiency	>85%
Total Output Power	25W
Protections	OCP, OVP, OLP,OTP
XYZ Dimension	69 x 42 x 24 mm
ROHS Compliance	Yes

Evaluation Board



Figure 1: Top View

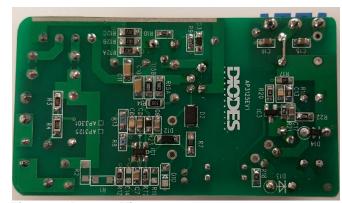
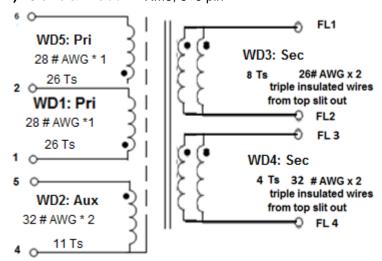


Figure 2: Bottom View



AP3125 (90 V_{AC} ~ 230 V_{AC} 2 outputs 25W Transformer Spec.)

1) Core & Bobbin: RM8, 6+6 pin



2) Transformer Parameters

1. Primary Inductance (Pin1-Pin6), all other windings are open $Lp = 0.85mH \pm 5\%@1KHz$

3) Transformer Winding Construction Diagram

Item	Windings	Winding Specification
1	WD1-Primary Winding	Start from Pin 1, 28# AWG*1, 26Ts Two layers, end at Pin 2.
2	Insulation	1 Layer of insulation tape
3	Shielding Winding	Start from Pin 4, 34# AWG*2 with full layer winding, end flowing wire.
4	Insulation	1 Layer of insulation tape
5	WD2 Aux Winding	Start from Pin 5, 32# AWG x2, 11TsT one layers, end at Pin 4.
6	Insulation	2 Layers of insulation tape
7	WD3 N _S 1 Secondary Winding	Start from FL1 with white tube, triple of insulation 26# AWG*2, 8Ts, one layer, end fold back to top side with black tube.
8	WD4 N _S 2 Secondary Winding	Start from FL3, triple of insulation 32# AWG*2, 4Ts, one layer, end fold back to top side with FL4 with black tube.
9	Insulation	2 Layers of insulation tape
10	WD5-Primary Winding	Start from Pin 2, 28# AWG*1, 26Ts, Two layers, end at Pin 6.
11	Insulation	2 Layers of insulation tape

Evaluation Board Schematic

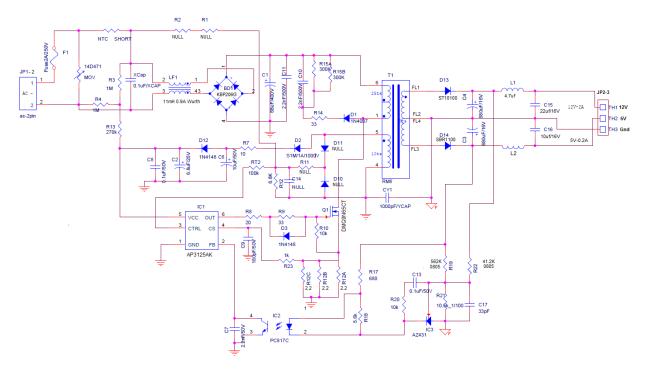


Figure 3: Evaluation Board Schematic

Evaluation Board Layout

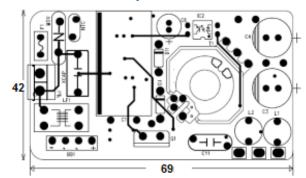


Figure 4: PCB Board Layout Top View

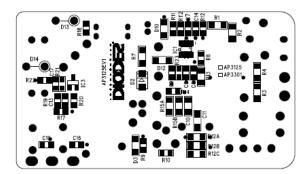


Figure5: PCB Board Layout Bottom View

Quick Start Guide

- 1. The evaluation board is preset at 12V/2A from TH1 ~TH3 & 5V/0.2A from TH2~TH3
- 2. Ensure that the AC source is switched OFF or disconnected.
- 3. Connect the AC line wires of power supply to "L and N" on the left side of the board.
- 4. Turn on the AC main switch.
- 5. Measure TH1~TH3 and TH2~TH3 to ensure correct output voltages at 12V and 5V, respectively.



Build of Material:

Item	Qty	Reference	AP3125A EV1 08-05-2016	Size	Company
1	1	C1	68μF/400V, AL Cap	16 * 25mm	Wurth
2	1	C2	6.8μF/25V, Ceramic Cap	X7R, ±10%, SMD0805	X7R, ±10%
3	1	C4	680μF/16V, Polymer Cap	10 * 13mm	Wurth
4	1	С3	220μF/16V, AL Cap	8 * 11mm	Wurth
5	1	C6	10μF/50V, AL Cap	5 * 11mm	Wurth
6	1	C7	2.2nF/50V	X7R, ±10%, 0805	Wurth
7	1	C8	0.1μF/50V	X7R, ±10%, 0805	Wurth
8	1	C9	180pF/50V	X7R, ±10%, 0805	Wurth
9	1	C10 & C11	2.2nF/500V	X7R, ±10%, 1206	
10	1	C13	0.1μF/50V	X7R, ±10%, 0805	Wurth
11	1	C14	NULL		
12	1	C15 & C16	10μF/16V, SMDCap	Y5U, ±10%, SMD0805	
13	1	C17	33pF	NPO, ±10%, SMD0805	
14	1	R1 & R2	NULL		
15	1	R3 & R4	1M ohm	SMD 1206	
16	1	R5 & R6	NULL		
17	1	R7	10Ω	±5%, SMD0805	
18	1	R8	20Ω	±5%, SMD0805	
19	1	R9	33Ω	±5%, SMD0805	
20	1	R10	10ΚΩ	±5%, SMD0603	
21	1	R11	NULL	±5%, SMD0805	
22	1	R12	6.8ΚΩ	±5%, SMD0805	
23	1	R12A/B/C	2.2\Omega / 2.2\Omega / 2.2\Omega	±1%, SMD1206	
24	1	R13	270ΚΩ	±5%, SMD1206	
25	1	R14	33Ω	±5%, SMD1206	
26	2	R15A/B	300ΚΩ	±5%, SMD1206	
27	1	R17	680Ω	±5%, SMD0805	



1	1	I	I	1	1
28	1	R18	5.6ΚΩ	±5%, SMD0805	
29	1	R19	562ΚΩ , 5%	1%, SMD0805	
30	1	R20	10KΩ ±5%, SMD0805		
31	1	R21	10.5ΚΩ, 1%	±1%, SMD0805	
32	1	R22	41.2ΚΩ, 1%	±1%, SMD0805	
33	1	RT2	100ΚΩ	±5%, SMD0805	
34	1	Q1	MOSFET, DMG9N65CT	TO220F	Diodes
35	1	IC1	PWM, AP3125AK,	SOT23-6	Diodes
36	1	IC2	Opto PC817C,	DIP	
37	1	IC3	AZ431, SOT-23	SMD	Diodes
38	1	T1	RM8, 850µH		
39	1	BD1	Bridge, KBP206G, 2A-600V	DIP	Diodes
40	1	D1	1N4007, 1A, 1,000V	DIP	Diodes
41	1	D2	S1M, 1A, 1,000V	SMD	Diodes
42	1	D3, D12	1N4148WS, 75V, SOD323	SMD	Diodes
43	1	D13	Schottky, ST10100, TO220-2	DIP	
44	1	D14	SBRB1100 1A, 100V, DOS123	SMD	Diodes
45	1	LF1	11mH 0.9A COM chock	DIP	Wurth
46	1	L1 & L2	L1 = 4.7µH , L2 shorted	DIP	
47	1	NTC	Shorted		
48	1	CY1	1000pF/Ycap	DIP	250V/Y1
49	1	Хсар	0.1μF/Xcap	DIP	275/X1 305Vac
50	1	Mov	14D471	DIP	
51	1	F1	Fuse 2A/250V	DIP	Slow
52	1	JP1	Terminal Block 2P	DIP	
53	2	JP2	Terminal Block 3P	DIP	



Input & Output Characteristics

Input Standby Power

Input Voltage	115Vac/60Hz	230Vac/50Hz	Note
Pin (w)	78mW	154m W	No loading

Input power Efficiency at different loading

AC input	Efficiency (%)					Eff_avg at four
AC input	10%	25%	50%	75%	100%	conditions
90VAC/60Hz					85,2%	
115VAC/60Hz	82.9%	86.9%	87.4%	86.6%	86.5%	86.8%
230VAC/50Hz	78.8%	88.0%	87.1%	87.2%	87.3%	87.4%
264VAC/50Hz					87.5%	
Eff_avg						

Output Characteristics:

Line Regulation (at full loading condition):

AC inpu	ıt Voltage	90VAC/60Hz	115VAC/60Hz	230VAC/50Hz	264VAC/50Hz	Note
outputo.	5.00Vo	5.52V/0.2A	5.50V/0.2A	5.52V/0.2A	5.52V/0.2A	0.5%<
outputs	12.00Vo	12.01V/2A	12.01V/2A	12.02V/2A	12.01V/2A	0.5%<

Cross Load Regulation (at nominal line AC input voltage):

Loading conditions	12V= FL & 5V=10%FL	12V=10% FL & 5V= FL
Conditions	12V/2A & 5V/0.02A	12V/0.2A & 5V /0.2A
115VAC	12.04V / 2A + 5.708V/0.02A	12.13V/0.2A + 4.94V/0.2A
230VAC	12.04V /2A + 5.714V/0.02A	12.13V/0.2A + 4.94V/0.2A

Current setting with at different AC line

AC input	90VAC	115VAC	230VAC	264VAC	Note
I _max	2.67A	2.69A	2.73A	2.78A	

Note: All output voltages are measured at output PCB board Edge.

Key Performance Waveforms:

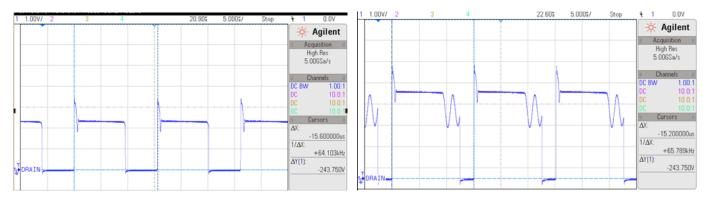


Fig:6 Vds at full load by using DF probe 1:100 at 115VAC

Fig:7 Vds at full load by using DF probe 1:100 at 230VAC

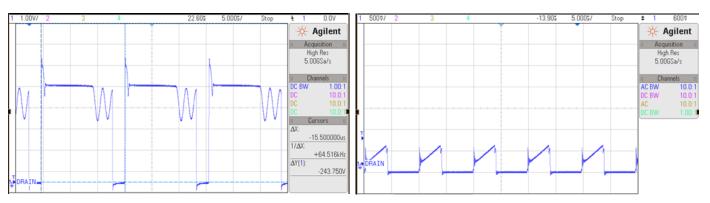


Fig:8 Vds at full load using DF probe 1:100 at 265VAC

Fig:9 Vcs at 90VAcin at FL

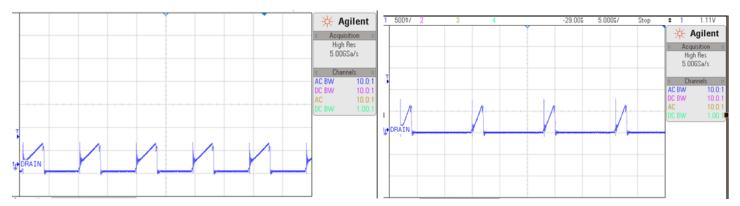


Fig:10 Vcs at 115Vacin at FL

Fig:11 Vcs at 264Vacin at FL

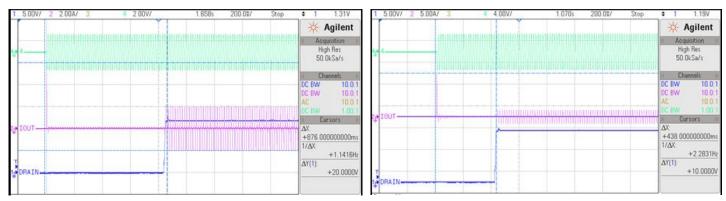
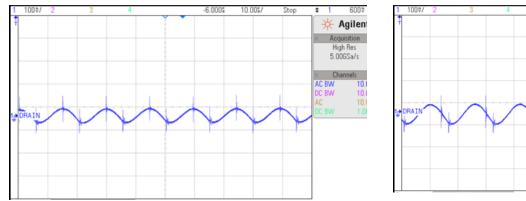


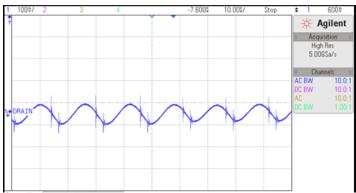
Fig:12 Turn on VAC_in, IAC_in, 12Vo at 115Vac at FL

Fig:13 Turn on VAC_in, IAC_in, 12Vo at 230Vac at FL

Output Performance Waveforms

All of the 12V ripple by using a 1:1 Probe in a 100mV/division.





🔆 Agilent

Figure:14 12V Ripple at 115Vac at FL.

Figure:15 12V Ripple at 230Vac at FL 6000 🔆 Agilent

Figure:16 5Vo Ripple at 115Vac at FL

Figure:17 5V Ripple at 230Vac at FL



Please see the recommand Application note for reference (Web page - http://www.diodes.com/appnote_dnote.html)

- 1) For AP3125 operation & set up, please review the Application note: **Application note 1120 Green Mode PWM Controller**
- 2) For PSU PCB layout consideration, please review the App note: AN1062 High Voltage Green Mode PWM Controller AP3105
- For the basic Flyback topology calculation, please review the App note: AN1045 Design Guidelines for Off-line AC-DC Power Supply Using BCD. PWM Controller AP3103

Thermal Test data at room Temperature after running 1 hr

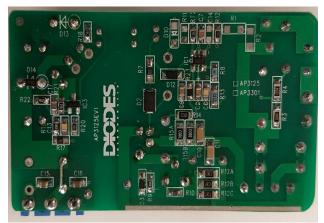


Figure: 18 SMD components UP side

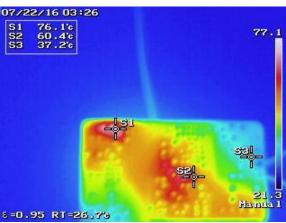


Figure:19 SMD side Vin=115V_{AC}, Test time=1hour



Figure: 20 Board Top components side



Figure:21 Vin=115V_{AC}, Testing time = 1.15 hour



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